

**Surface Mounted Chip LED**
**Model No. : CL-SP155UHRDNB**
**■ Features :**

- Compatible with automatic placement equipment
- Compatible with reflow solder process

**■ Applications :**

- Automotive\_Telecommunication
- Indicators
- LCD Back-lights
- Illuminations

**Absolute Maximum Ratings**
**( Ta=25°C )**

| Item   | Symbol           | Maximum    | Unit  |
|--|------------------|------------|-------|
| Peak Forward Current (1/10 Duty Cycle 0.1ms Pulse Width) | I <sub>FP</sub>  | 100        | mA    |
| Reverse Voltage  | V <sub>R</sub>   | 5          | V     |
| Derating Linear From 25°C                                |                  | 0.4        | mA/°C |
| Operating Temperature Range                              | T <sub>opr</sub> | -30 to +80 | °C    |
| Storage Temperature Range                                | T <sub>stg</sub> | -40 to +85 | °C    |

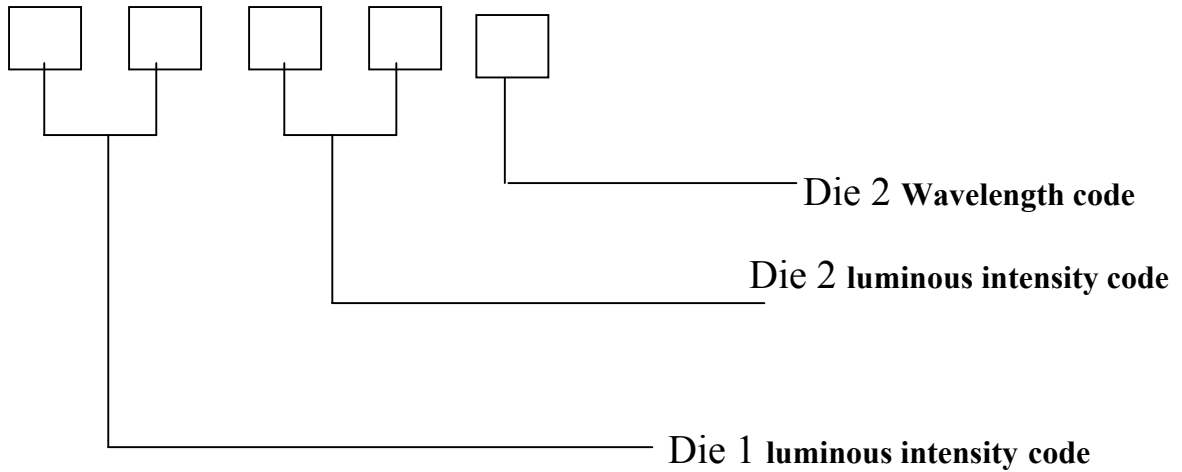
**Electrical / Optical Characteristics**
**( Ta=25°C )**

| Chip           |                     |                     | Lens Appearance | Absolute Maximum Rating |         |         | Electro-optical Data (At 20mA) |      |                      |     | Viewing Angle 2θ 1/2 (deg) |
|----------------|---------------------|---------------------|-----------------|-------------------------|---------|---------|--------------------------------|------|----------------------|-----|----------------------------|
| Emitted Color  | λ <sub>P</sub> (nm) | λ <sub>D</sub> (nm) |                 | Δλ (nm)                 | Pd (mW) | If (mA) | V <sub>f</sub> (V)             |      | I <sub>v</sub> (mcd) |     |                            |
|                | Typ.                | Max.                |                 |                         |         |         | Min.                           | Typ. |                      |     |                            |
| Ultra High Red | 645                 | 631                 | Water Clear     | 15                      | 78      | 30      | 2.1                            | 2.6  | 72                   | 115 | 130°                       |
| Blue           | 468                 | 470                 |                 | 25                      | 100     | 25      | 3.5                            | 4.2  | 72                   | 115 |                            |

|       |                |           |            |
|-------|----------------|-----------|------------|
| ISSUE | DIMENSION NO : | VERSION : | DATE :     |
|       |                | A         | 2009/03/12 |
|       | APPROVAL :     | CHECK :   | EDIT :     |
|       |                |           |            |

◆ Packing coding principle

Notice: Bin code: luminous intensity / wavelength.



◆ The Luminous Intensity Grade of Red Chip-LED Products

● Test Condition : @ 20mA

| Range,mcd | Bin code |
|-----------|----------|
| 72/90     | K1       |
| 90/115    | K2       |
| 115/145   | L1       |
| 145/180   | L2       |

◆ Dominant Wavelength Grade of Red Chip-LED Products

● I type @ 20mA

| BIN | Range   |
|-----|---------|
|     | 624/634 |

◆ The Luminous Intensity Grade of Blue Chip-LED Products

● Test Condition : @ 20mA

| Range,mcd | Bin code |
|-----------|----------|
| 72/90     | K1       |
| 90/115    | K2       |
| 115/145   | L1       |
| 145/180   | L2       |

◆ Dominant Wavelength Grade of Blue Chip-LED Products

● I type @ 20mA

| BIN | Range   | BIN | Range   |
|-----|---------|-----|---------|
| 1   | 465/468 | 2   | 468/471 |

◆ **Descriptions :**

- The Chip-LED Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature application, etc.

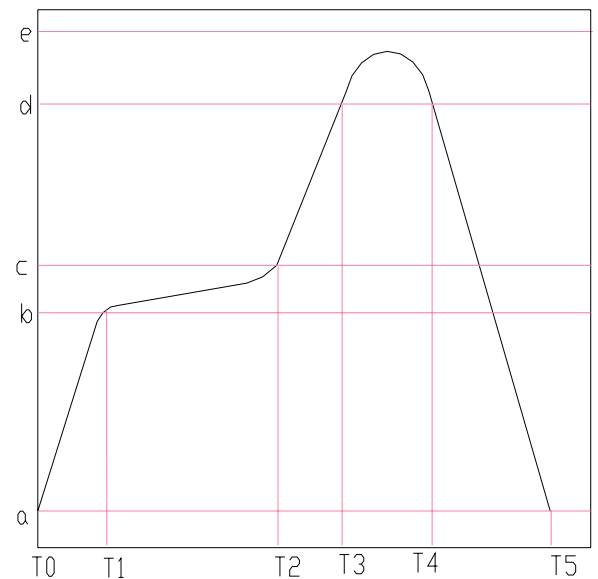
◆ **Reliability Test Items And Conditions :**

| NO. | Item                             | Test Conditions                                  | Test Hours / Cycle | Sample Q'ty | Ac / Re |
|-----|----------------------------------|--|--------------------|-------------|---------|
| 1   | Solder Heat                      | TEMP : 260°C±5°C                                 | 5 sec              | 36 pcs      | 0 / 1   |
| 2   | Temperature Cycle                | H : +100°C 30min.<br>∫ 5min.<br>L : -40°C 30min. | 50 cycle           | 36 pcs      | 0 / 1   |
| 3   | Thermal Shock                    | H : +100°C 5min.<br>∫ 10sec<br>L : -40°C 5min.   | 50 cycle           | 36 pcs      | 0 / 1   |
| 4   | High Temperature Storage         | TEMP : 100°C                                     | 1000 hrs           | 36 pcs      | 0 / 1   |
| 5   | Low Temperature Storage          | TEMP : -40°C                                     | 1000 hrs           | 36 pcs      | 0 / 1   |
| 6   | DC Operating Life                | I <sub>F</sub> = 20mA                            | 1000 hrs           | 36 pcs      | 0 / 1   |
| 7   | High Temperature / High Humidity | 85°C / 90~95%R.H.                                | 1000 hrs           | 36 pcs      | 0 / 1   |

◆ **Reflow Temp. / Time :**

Please refer to the following figure :

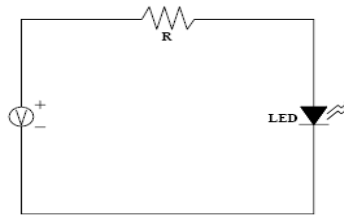
| Temp.(°C)  |     | Time(Sec)    |                |
|------------|-----|--------------|----------------|
| a          | 25  | T0~T1        | Max. 3°C/sec   |
| b          | 150 | T1~T2        | 90~130 sec     |
| c          | 200 | T2~T3        | Max. 3°C/sec   |
| d          | 220 | T3~T4        | Max. 30~50 sec |
| e          | 250 |              |                |
|            |     | T4~T5        | Max. -3°C/sec  |
| Blet Speed |     | 70~90 cm/min |                |



◆ **Precautions For Use :**

- Over - current - proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change ( Burn out will happen )



- Storage

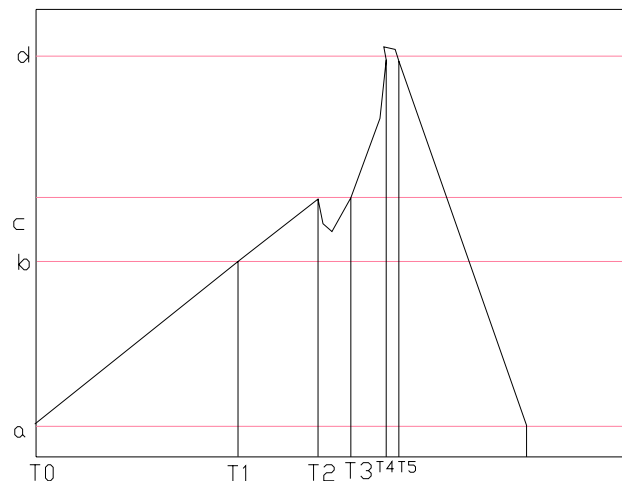
1. The operation of temperature and R.H. are :  $5^{\circ}\text{C} \sim 30^{\circ}\text{C}$  , R.H.60% Max..
2. Once the package is opened, the products should be used within 72 hrs. Otherwise, they should be kept in a dampproof box with desiccating reagent. Considering the tape life, we suggest our customers to use our products within 1 year ( from production date ) .
3. It's recommended to bake before soldering when the package is unsealed after 72 hrs. The condition is :  $80^{\circ}\text{C} \pm 5^{\circ}\text{C}$  for 24hrs.

◆ **Soldering Iron :**

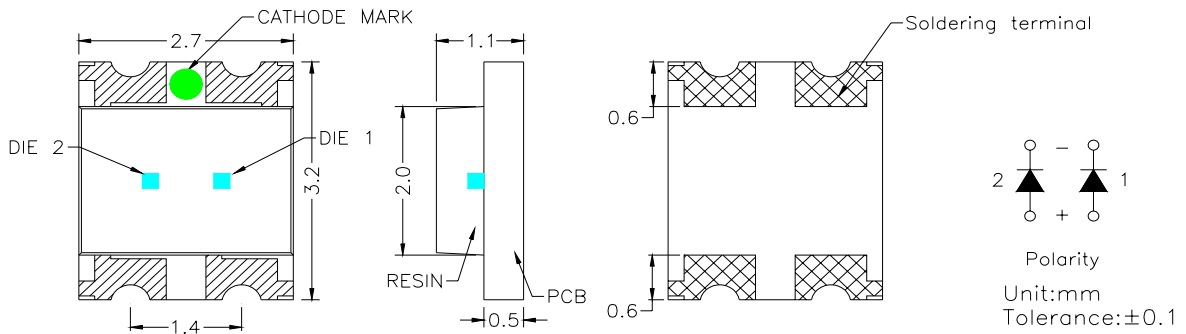
- Temperature at tip of iron :  $300^{\circ}\text{C}$  Max. ( 25W Max. )
- Soldering time :  $5 \pm 1\text{sec}$ .

◆ **Wave Soldering Temp. / Time :**

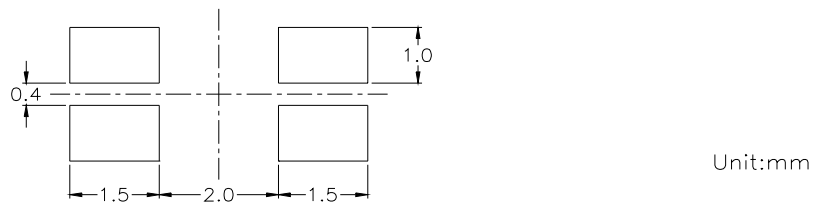
| Temp.( $^{\circ}\text{C}$ ) |              | Time(Sec) |             |
|-----------------------------|--------------|-----------|-------------|
| a                           | 25           | T1~T2     | $60 \pm 20$ |
| b                           | $130 \pm 10$ | T2~T3     |             |
| c                           | 185          | T3~T6     |             |
| d                           | $250 \pm 3$  | T4~T5     | $3 \pm 2$   |
|                             |              |           |             |



◆ Package Dimensions of Device

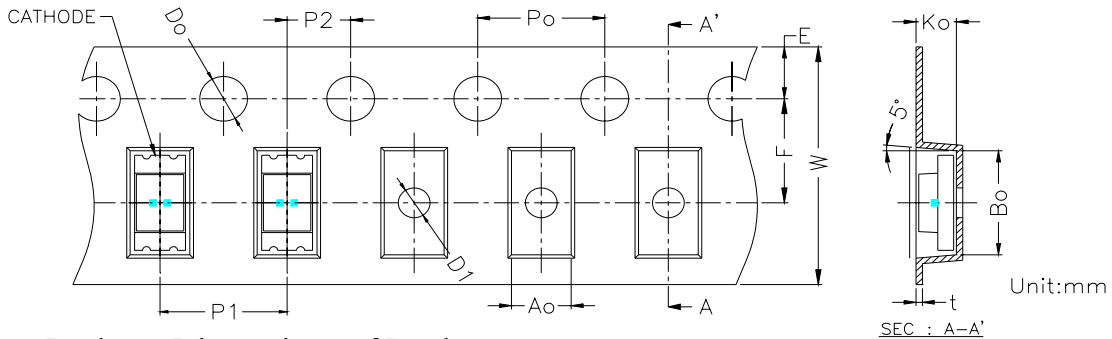


◆ Recommended Soldering Pad Dimensions

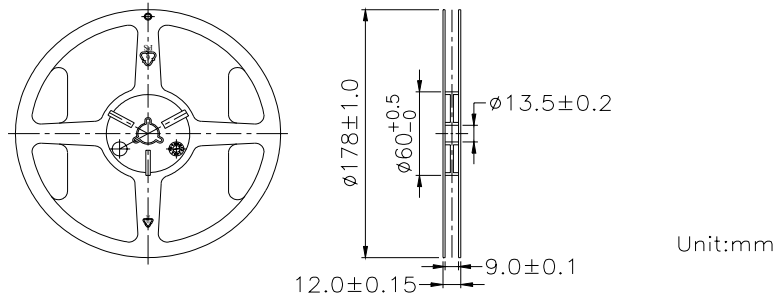


◆ Tape Specification : 3000pcs Per Reel

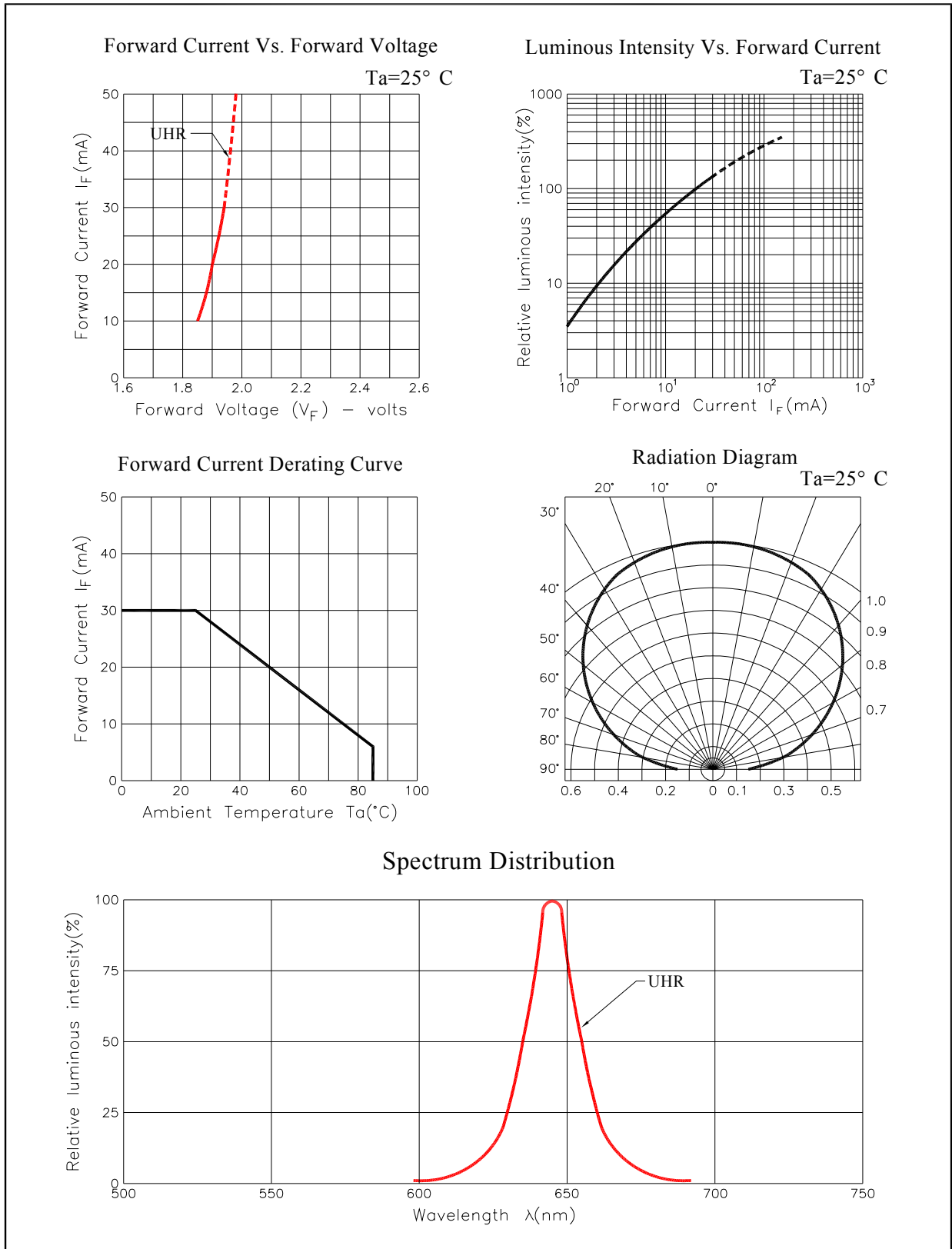
| Packing Size |       |       |       |       |                    |       |       |       |       |       |       |       |       |
|--------------|-------|-------|-------|-------|--------------------|-------|-------|-------|-------|-------|-------|-------|-------|
| Item         | W     | P1    | E     | F     | Do                 | D1    | Po    | 10Po  | P2    | Ao    | Bo    | Ko    | t     |
| Spec.        | 8.00  | 4.00  | 1.75  | 3.50  | 1.50               | 1.00  | 4.00  | 40.00 | 2.00  | 2.80  | 3.35  | 1.35  | 0.22  |
| Tolerance    | ±0.20 | ±0.10 | ±0.10 | ±0.05 | $^{+0.10}_{-0.00}$ | ±0.05 | ±0.05 | ±0.20 | ±0.05 | ±0.10 | ±0.10 | ±0.10 | ±0.05 |



◆ Package Dimensions of Reel :



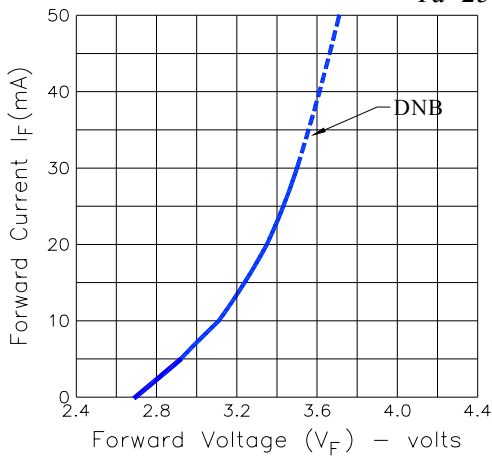
◆ Typical Electro-Optical Characteristic Curves:



◆ **Typical Electro-Optical Characteristic Curves:**

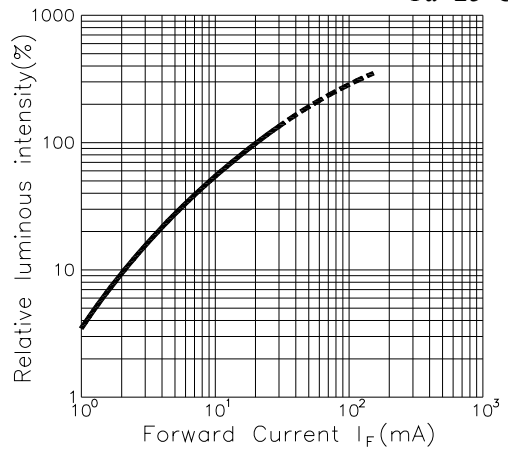
Forward Current Vs. Forward Voltage

Ta=25°C

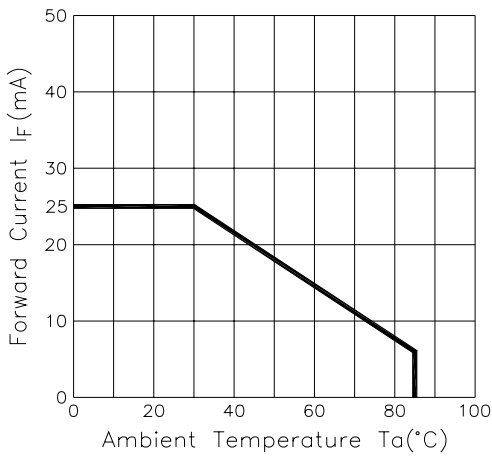


Luminous Intensity Vs. Forward Current

Ta=25°C

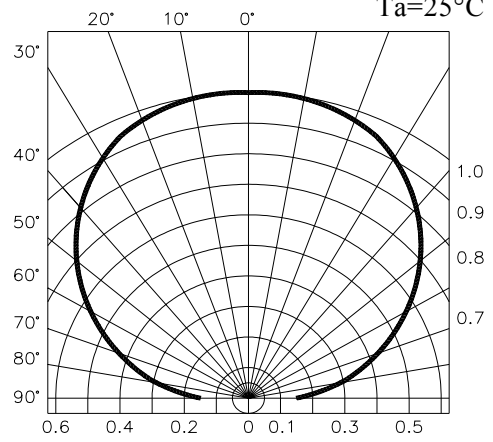


Forward Current Derating Curve

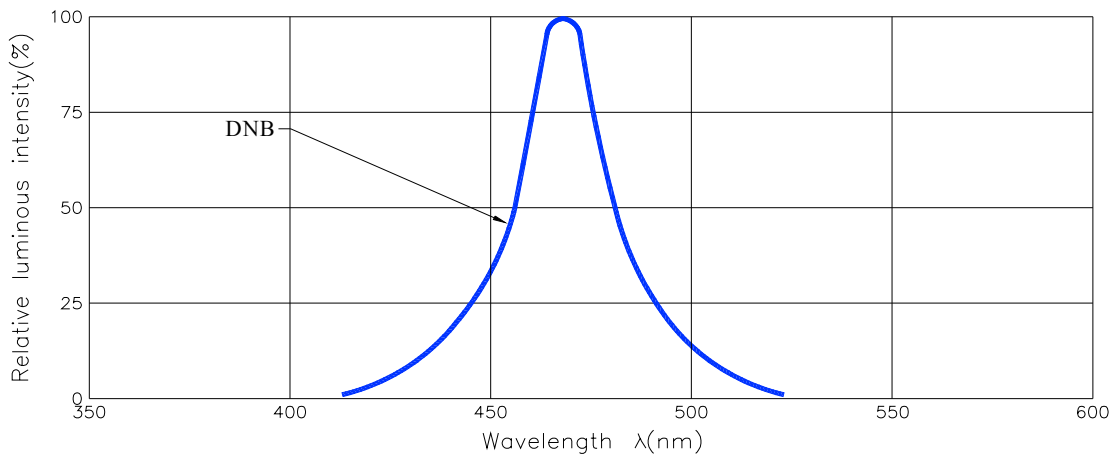


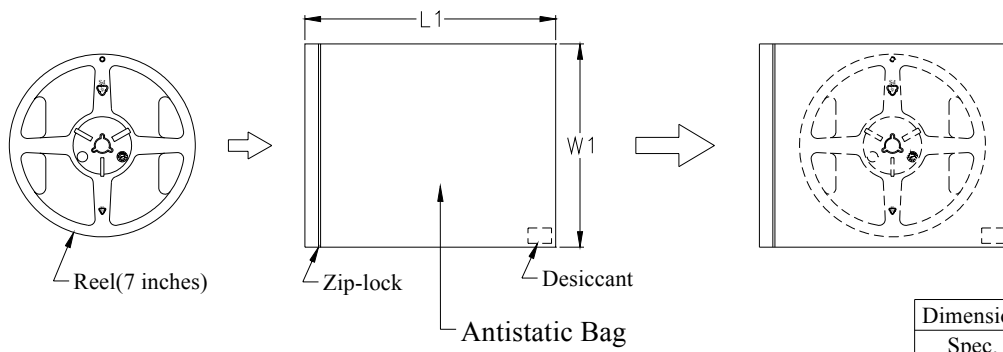
Radiation Diagram

Ta=25°C



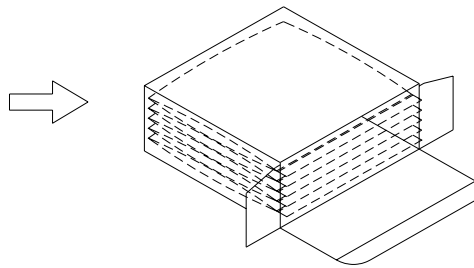
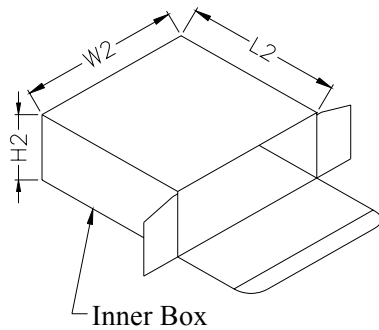
Spectrum Distribution





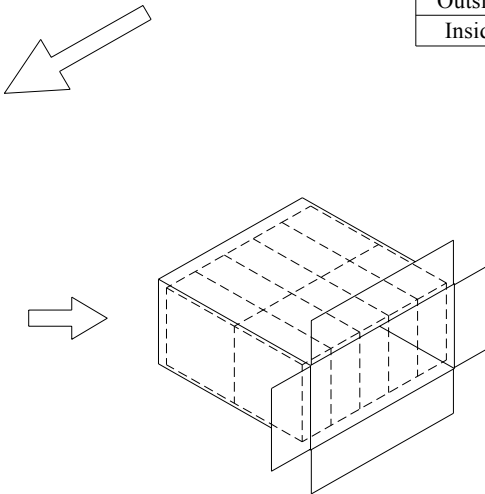
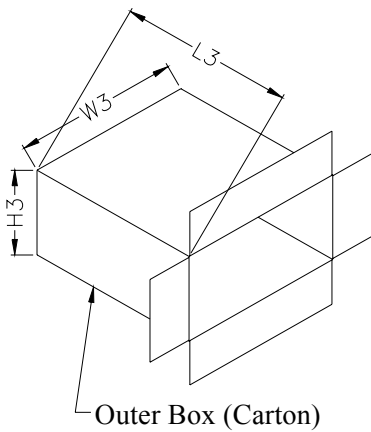
| Dimension | L1    | W1    |
|-----------|-------|-------|
| Spec.     | 203.0 | 198.0 |

Unit : mm



| Dimension | L2    | W2    | H2   |
|-----------|-------|-------|------|
| Outside   | 200.0 | 205.0 | 85.0 |
| Inside    | 193.7 | 198.7 | 78.7 |

Unit : mm



| Dimension | L3    | W3    | H3    |
|-----------|-------|-------|-------|
| Outside   | 448.0 | 424.0 | 220.0 |
| Inside    | 433.4 | 409.4 | 205.4 |

Unit : mm